

UNITED STATICATION DEPARTMENT OF COMMERCE Patent and Trademark Office

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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO.

1187893.917 U7711797 LITTAU K AM2119712130

IM62/0824

EXAMINER

ZERVIGUN, R

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ART UNIT PAPER NUMBER

DATE MAILED:

08/24/99

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

· FILECORY

Office Action Summary

Application No. 08/893,917

Applicant(s)

Examiner

Littau et al Group Art Unit

Rudy Zervigon

1763



Responsive to communication(s) filed on	·
☐ This action is FINAL .	
☐ Since this application is in condition for allowance except for in accordance with the practice under <i>Ex parte Quayle</i> , 193	
A shortened statutory period for response to this action is set is longer, from the mailing date of this communication. Failure application to become abandoned. (35 U.S.C. § 133). Extens 37 CFR 1.136(a).	to respond within the period for response will cause the
Disposition of Claims	
	is/are pending in the application.
Of the above, claim(s)	is/are withdrawn from consideration.
☐ Claim(s)	
☐ Claim(s)	
Application Papers ☐ See the attached Notice of Draftsperson's Patent Drawir	na Review. PTO-948.
☐ The drawing(s) filed on is/are object	
☐ The proposed drawing correction, filed on	
☐ The specification is objected to by the Examiner.	
☐ The oath or declaration is objected to by the Examiner.	
Priority under 35 U.S.C. § 119	
Acknowledgement is made of a claim for foreign priority	under 35 U.S.C. § 119(a)-(d).
☐ All ☐ Some* ☐ None of the CERTIFIED copies of	
☐ received.	•
received in Application No. (Series Code/Serial Nu	mber)
\square received in this national stage application from the	International Bureau (PCT Rule 17.2(a)).
*Certified copies not received:	
☐ Acknowledgement is made of a claim for domestic prior	ity under 35 U.S.C. § 119(e).
Attachment(s)	
☑ Notice of References Cited, PTO-892	
X Information Disclosure Statement(s), PTO-1449, Paper N	lo(s) <u>5</u>
☐ Interview Summary, PTO-413	
☐ Notice of Draftsperson's Patent Drawing Review, PTO-9	48
□ Notice of Informal Patent Application, PTO-152	
SEE OFFICE ACTION ON	THE FOLLOWING PAGES

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-4,6,8,9,11-15 are rejected under 35 U.S.C. 102(b) as being clearly anticipated by Kawamura (U.S. Pat. 5,328,558). Kawamura describes a dry etching apparatus using a method for etching silica film with the use of a gas (column 1, lines 1-2). Specifically, the limitations set forth in the rejected claims are explicitly detailed by Kawamura:
- a. Remote plasma formation (column 3, lines 50-60) relative to substrate processing chamber (Column 4, lines 13-18).
- b. Diluent gas flow (column 3, lines 59-66) forming a mixture of reactive radicals and diluent gas anterior to a wafer processing chamber (Column 4, lines 13-18).
- c. Total pressure (comprising diluent gas and plasma gas) less than 1 Torr (column 4, lines 24-25, column 5, lines 63-64, column 6, lines 2-4)
- d. The dependance of the rate at which a chamber residue gas is exhausted compared to the rate of a diluent gas flow is implicitly described according to the geometry of the piping as described by Kawamura. Accordingly, Kawamura's chamber residue gas is exhausted

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depending on the rate of a diluent gas flow that arrives in the processing chamber. A common assumption in fluid dynamics is that most fluids are incompressible, and for a constant processing chamber pressure to be established, fluid continuity equations dictate that, at steady-state, the flow into the processing chamber must equal the flow from the processing chamber.

- 3. Claims 1-15 are rejected under 35 U.S.C. 102(b) as being clearly anticipated by Moslehi (U.S. Pat. 5,403,434). Moslehi (U.S. Pat. 5,403,434) describes a low temperature in-situ dry cleaning etching apparatus and method with the use of a gas (column 1, lines 13-24). Specifically, the limitations set forth in the rejected claims are explicitly detailed by Moslehi (U.S. Pat. 5,403,434):
- e. Remote plasma formation (column 9, lines 6-10) relative to substrate processing chamber (Column 9, lines 10-17).
- f. Diluent gas flow (column 11, lines 37-44) forming a mixture of reactive radicals and diluent gas anterior to a wafer processing chamber (Column 9, lines 10-17).
- g. Total pressure (comprising diluent gas and plasma gas) less than 1 Torr (column 3, lines 16-20)
- h. Diluent gas flow comprises a reduction gas, in this case hydrogen (column 11, lines 37-44).
- i. Fluorinated gases (column 4, lines 31-36)
- j. The dependance of the rate at which a chamber residue gas is exhausted compared to the rate of a diluent gas flow is implicitly described according to the geometry of the piping as described by Moslehi. Accordingly, Moslehi's chamber residue gas is exhausted via pumping

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system (item 30, Figure 1) depending on the rate of a diluent gas flow that arrives in the processing chamber. A common assumption in fluid dynamics is that most fluids are incompressible, and for a constant processing chamber pressure to be established, fluid continuity equations dictate that, at steady-state, the flow into the processing chamber must equal the flow from the processing chamber.

k. Relative gas flow rates for the diluent gas (hydrogen) and the plasma forming gas (Ge_2H_6) meeting the claim 7 limitation is explicitly met (column 10, lines 53-59).

Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 16-20 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kawamura (U.S. Pat. 5,328,558) or Moslehi (U.S. Pat. 5,403,434) in view of Stevens et al (U.S. Pat.5,302,803). The apparatus and methods of Kawamura (U.S. Pat. 5,328,558) and Moslehi (U.S. Pat. 5,403,434) have been discussed above. Kawamura (U.S. Pat. 5,328,558) and Moslehi (U.S. Pat. 5,403,434) do not specifically discuss microwave arrestors and apertures with regards to their microwave plasma generation sources. Stevens et al discuss a microwave applicator using both an input aperture and output aperture with microwave arrestors (column 9, lines 24-32).

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It is the examiner's position that a person of ordinary skill in the art at the time the invention was

made would have found it obvious to modify the Kawamura (U.S. Pat. 5,328,558) or Moslehi (U.S.

Pat. 5,403,434) microwave sources by introducing Stevens et al's microwave applicator using both

an input aperture and output aperture with microwave arrestors (column 9, lines 24-32). The Stevens

et al microwave applicator design using both an input aperture and output aperture with microwave

arrestors (column 9, lines 24-32) is a common practice in the art limiting the extent of microwave

permeation to the volume of gas intended for discharge.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner 6.

should be directed to Examiner Rudy Zervigon whose telephone number is (703) 305-1351. The

examiner can normally be reached on a Monday through Friday schedule from 8am until 5pm. The

official AF fax phone number for the 1763 art unit is (703) 305-3599. Any Inquiry of a general

nature or relating to the status of this application or proceeding should be directed to the Chemical

and Materials Engineering art unit receptionist at (703) 308-0661.

Bruce Breneman Supervisory Patent Examiner **Technology Center 1700**